

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	84	W	8/20µs, per Figure 1
Peak Pulse Current	I _{PP}	6	А	8/20µs, per Figure 1
ESD Protection – Contact Discharge	VESD_Contact	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

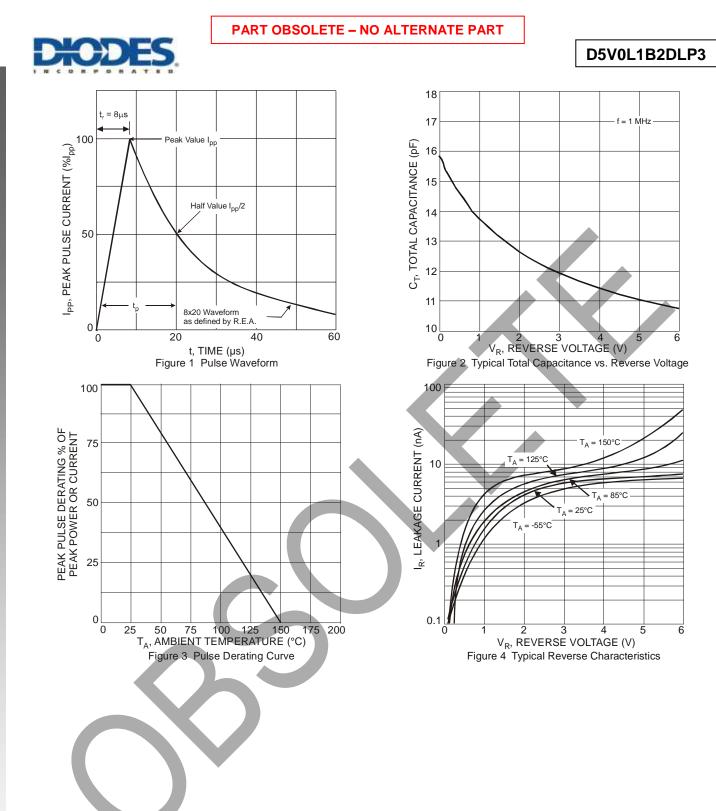
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	D°

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	-	_	5	V	—
Channel Leakage Current (Note 6)	I _{RM}	-	10	100	nA	$V_{RWM} = 5V$
Clamping Voltage, Positive Transients			7.0	9.0	V	$I_{PP} = 1A, t_p = 8/20\mu S$
	N		8.7	10.7		$I_{PP} = 3A, t_p = 8/20\mu S$
	V _{CL}	—	10.5	12.0		$I_{PP} = 5A, t_p = 8/20\mu S$
		_	11.5	14.0		$I_{PP} = 6A, t_p = 8/20\mu S$
Breakdown Voltage	V _{BR}	6	7	8	V	I _R = 1mA
Differential Resistance	RDIF	-	0.2	—	Ω	$I_R = 1A, t_p = 8/20\mu S$
Channel Input Capacitance	C _{IN}		15	18	рF	$V_R = 0V, f = 1MHz$
		_	12.5	_		V _R = 2.5V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

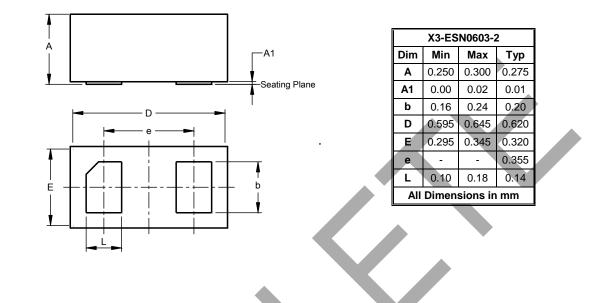
6. Short duration pulse test used to minimize self-heating effect.





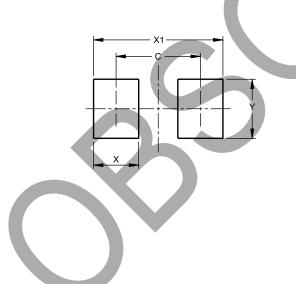
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.355		
Х	0.190		
Y	0.250		
X1	0.545		

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